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Optimization of the soldering process by the DMAIC methodology

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Abstract The chapter presents use of the DMAIC method for the analysis and improvement of the process of soldering pins in a plug connecting a bundle of wires to the board of a controller, part of the steering system of a passenger car. The main problem in the soldering process - an unsatisfactory share of bad soldered connections between the board and the plug and the instability of that number - was identified using a five-phase improvement process. Key points and main causes of the defect were pointed out, and process improvement measures suggested. Due to the analysis conducted and the correct implementation of improvement measures the share of defective connections has been decreased twofold.

Key words – improvement, process, soldering, six sigma, production, quality

1. Introduction

Striving to constantly improve and streamline the production process, the modern quality engineer has many methods of quality management at their disposal (TAGUE N.R., 2004. SKOTNICKA-ZASADZIEŃ B., GLENC D., 2006. KRYNKE M., MIELCZAREK K., 2013). Apart from these, many other less complicated tools are used, such as the Pareto diagram, the Ishikawa diagram or the 5 WHYs (MIDOR K., 2014. SYGUT P., 2014). One of the elements of streamlining a production process can be the DMAIC (Define - Measure -Analyze - Improve - Control) method, which originated in the automotive industry and is successfully used in improving processes in accordance with the assumptions of Six Sigma (GOŁĘBIOWSKI M., 2010. Krzemień E., Wolniak R., 2007. Wojtaszak M., BIAŁY W., 2013).

The improvement cycle using the DMAIC method consists of the following elements:

- Define. During this stage, a team of people who are going to be responsible for defining the clients of the given production process, their needs and requirements.
- Measure. The team is tasked with creating a map of the process which requires improvement. Main measures of effectiveness and efficiency should be defined at this point in order to use the concept of Six Sigma.
- Analyse. During this stage, by analysing the individual parameters of the process, the team will be able to determine the causes of the problem, which will then have to be eliminated or fixed.
- Improve. The penultimate stage of the improvement method, during which all the measures introduced are summed up.

 Control. After applying corrective measures comes a control of the improvements introduced (ECKES G., 2000).

It is worth noticing here that the cycle of introducing the DMAIC method is completely compatible with the concept of constant improvement proposed by E. Deming (DEMING W.E., 2000) required by the ISO 9001 series standards and continuously developed (JAGUSIAK-KOCIK M., 2014). Figure 1 shows a comparison of both concepts.



Fig. 1 PDCA vs DMAIC (SOKOVIC M., PAVLETIC D., KERN PIPAN K., 2010)

During the implementation of the DMAIC method, a number of supplementary methods and techniques are used in the form of quality improvement tools and methods.

2. Example problem solution

2.1. Defining the problem

The first stage of the DMAIC methodology is problem identification. In the case of the analysed example, it is the presence of defects in the soldered connection between the plug of a bundle of wires and the printed circuit board. The problem is not only the number of defective connections, but also the fact that it fluctuates. Over a period of 30 weeks the number fluctuated in the $4\ 000\ - 16\ 000\ PPM$ range. The goal of the project was to reduce the number of defective connections to the level of $< 3\ 000\ PPM$.

In the soldering process there are three effects of bad quality soldered connections which result from the analysis of the defect sheets and constitute a tangible loss to the company. The following types are distinguished:

- loss of cycle due to bad quality of the soldered connections, which require correction by the operator at the last visual control station,
- loss of cycle due to solder alloy (tin) breaking off from the spool during the soldering process,
- scrapping of damaged parts (Wire Harness and Controller Board plugs).

Having analysed all the elements of the process which could influence the high defect indicator and the variability of the soldering process, the following factors have been singled out:

- a lack of systematic technical inspections of the machines by the maintenance department,
- a lack of inspections of the technical condition of the pallets and their masks for the proper alignment of the plug, printed circuit board and wires in the soldering machine,
- unstable process of dispensing the flux onto the soldered area on the circuit board,
- inefficient pin and wires pre-heating process.

2.2. Measurements

At this stage of the DMAIC method, an SIPOC diagram was drawn up, which shows the key elements of the production process. SIPOC is a tool which makes it possible to map every step of a given process. The abbreviation comes from the words Suppliers, Inputs, Process, Outputs and Customers, and consists of the following elements:

- supplier a person (or group of persons) who supplies key information and input materials for the process,
- inputs materials, information input into the process along with the requirements,
- process a set of activities which transforms input elements into output elements,
- outputs materials, information which exits the process,
- customer a person, a group of persons or a process which receives the final product and their requirements for the products (NOWAKOWSKA M., 2012).

Following that, we identified and described all the operations required in the soldering process as well as which machines take part in individual operations. We also described all the important process parameters and the order of conducting individual operations and procedures (e.g. the amount of flux used, the position of the solder pin, pre-heating temperature of the soldered elements, the soldering order of individual pins, the solder alloy feeding rate, the position of pallets and masks). Based on these pieces of information, a map of the process was created in a graphic form showing all

the phases of the process along with their key inputs and outputs.

2.3. Analysis

At this stage of the project we analysed all the data on factors which could be the cause of defects in the soldering process. In order to find out how much of an impact the effects of defects in the soldering process have, a PFMEA (TAGUE N.R., 2004) was conducted for all the elements of the soldering process, i.e.:

- subassembly of the plug to the case,
- application of flux onto the soldering area,
- positioning the soldering head,
- the actual soldering process.

Using the PFMEA we identified which elements of the process have the highest WPR indicator value and which of them constitute a threat to the soldering process (WPR of at least 160). Table 1 presents the most significant potential causes of defective soldered connections. In total, 30 potential defect causes were analysed.

Table 1. PFMEA results

NO.	POTENTIAL CAUSES OF DEFECTS	RPN
1	Lack of skill on the operator's end	240
2	Incorrect position of the tool which positions the CCA board	160
3	Incorrect position of the robot's head	192
4	Needle contamination	192
5	Incorrect pre-wetting of the soldering pin	240
6	Soldering pin in bad technical condition	240
7	Oxidised binding material	168

2.4. Improvement

Based on the PFMEA results, the following measures were introduced to prevent the occurrence of defects:

- the operators were given training on examining the quality of the soldered connections in accordance with standards;
- a training was conducted on the proper positioning of tools which determine the board's position in the soldering machine (the pallet and the mask);
- new equipment for pre-heating the soldered elements was installed.

- sheets were introduced to control the technical functionality of the positioning tools - if the pallet generates three errors, the operator must inform their supervisor to remove it from the process;
- a procedure for cleaning soldering pins was introduced, taking place every day during the 1st shift, and potential replacement, should their technical condition warrant it;
- the soldering robots were equipped with counters which count the number of cycles performed by the soldering pin (one soldering point counts as one cycle performed by the robot);
- the amount of flux dispensed was set by regulating the opening time of the nozzle, the feeding pressure and the air pressure;
- the soldering alloy was changed from oxidised to unoxidised tin and it was winded properly onto the spool;
- instructions for changing sponges used for cleaning the soldering pin of deposits and tin once per shift was placed at the soldering station;
- cleaning the filter element in the fume exhaust system once per week.

2.5. Control

With the improvement stage finished, the project's primary focus shifted to constant monitoring of the measures implemented in order to maintain a sufficiently high level of quality of the products.

In order to verify the effectiveness of the corrective measures taken, another FMEA of the soldering process was conducted. The WPR indicator of all the defect causes analysed did not exceed 120.

After introducing the changes to the process, the number of defective elements decreased and reached the target level of $< 3\,000$ PPM. The variability in the number of defective connections over the course of a week also decreased; it currently oscillates between 1 000 and 2 700 PPM.

To ensure the durability of changes implemented into the process, a control plan was devised during the last stage of the analysis, consisting of the following elements:

- a list of elements in the process which need to be monitored and controlled along with the frequency of measurements,
- a list of streamlining measures and persons responsible for implementing and maintaining them,
- a list of standards implemented into the process.

Measurement and monitoring measures created as a result of the analysis conducted using the DMAIC method are presented in Table 2. The list of improvements and persons chosen to be responsible for their functioning are presented in Table 3.

Table 2. Monitoring and control

Control element	Defect indica- tor	Scrapped parts indicator
Control limit	3 000 PPM	PLN 2 500
Control frequency	1/day	1/month
Measurement	defect analysis	Scrapping re-
system	sheet	ports
Result presentation	Chart	Chart
Response plan	Measures taken at the morning meet- ing between the engineers and the project leader	Measures taken at the monthly summary meet- ings
Person responsi-	Quality engi-	Quality engi-
ble	neer	neer

Table 3. Monitoring and control

Person responsible	Measures taken
Technologist	Correct condition and
Technologist	temperature of the flux
Technologist	Correction of the flux
Technologist	feeding settings
	Counters of cycles per-
Production engineer	formed by the soldering
	pin
Production engineer	Soldering pin replacement
Floduction engineer	control sheets
Production engineer	Counter state control
Froduction engineer	sheets
	Soldering station instruc-
Technologist	tions - pin cleaning

Technologist	Unoxidised soldering alloy and its correct winding
Production engineer	Cleaning sponge replacement, 1/shift
Production engineer	Cleaning the filter element, 1/week
Production engineer	Control sheets of the tools positioning the boards in the soldering machine

In the last stage of creating the control plan, standardisation was incorporated (Table 4) whose goal is to maintain the standards which govern the improvement process.

Table 4. Standardisation

Person responsible	Measures taken
Technologist	Instructions, training and verifying the technical condition of pallets for persons responsible (operators)
Technologist	Instructions and training on the correct positioning of the soldering pin
Maintenance engineer	Prevention by the maintenance department within the soldering line
Production engineer	Instruction and training for the operators on examining the quality of soldered connections in accordance with the standard

3. Summary

Based on the case study conducted, we can conclude that:

- 1. The DMAIC method allows us to solve complex problems in the production process, improve it, and leads to tangible savings for the company.
- 2. The method requires the engagement of significant company resources, from the quality engineers and technologists to production and maintenance engineers.
- 3. Conducting the analysis in accordance with the methodology guarantees identification of the primary causes of the problem and minimising them effectively.

 Successful implementation of the control plan ensure protection of the production process in the future against disruptions caused by identified errors.

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